

AOK30B135W1

1350V, 30A Alpha IGBT™ with Diode

General Description

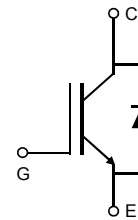
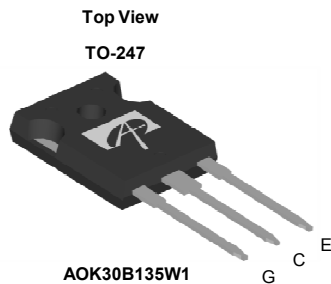
- Latest AlphaIGBT (α IGBT) technology
- Best in Class $V_{CE(SAT)}$ enables high efficiencies
- Low turn-off switching loss due to fast turn-off time
- Very smooth turn-off current waveforms reduce EMI
- Better thermal management
- High surge current capability
- Minimal gate spike due to high input capacitance

Applications

- Induction Cooking
- Rice Cookers
- Microwave Ovens
- Other soft switching applications

Product Summary

V_{CE}	1350V
I_C ($T_C=100^\circ\text{C}$)	30A
$V_{CE(sat)}$ ($T_C=25^\circ\text{C}$)	1.8V



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOK30B135W1	TO247	Tube	240

Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	AOK30B135W1	Units
Collector-Emitter Voltage	V_{CE}	1350	V
Gate-Emitter Voltage	V_{GE}	± 30	V
Continuous Collector Current	I_C	$T_C=25^\circ\text{C}$	60
		$T_C=100^\circ\text{C}$	30
Pulsed Collector Current, Limited by T_{Jmax}	I_{Cpulse}	120	A
Non repetitive peak collector current ^A	I_{CSM}	200	A
Turn off SOA, $V_{CE} \leq 600\text{V}$, Limited by T_{Jmax}	I_{LM}	120	A
Continuous Diode Forward Current	I_F	$T_C=25^\circ\text{C}$	60
		$T_C=100^\circ\text{C}$	30
Diode Pulsed Current, Limited by T_{Jmax}	I_{Fpulse}	120	A
Power Dissipation	P_D	$T_C=25^\circ\text{C}$	340
		$T_C=100^\circ\text{C}$	170
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 175	$^\circ\text{C}$
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	T_L	300	$^\circ\text{C}$

Thermal Characteristics

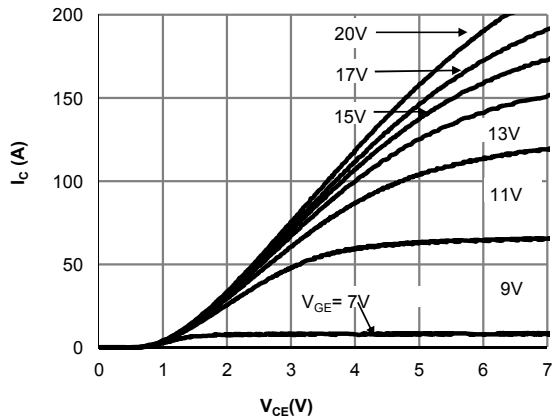
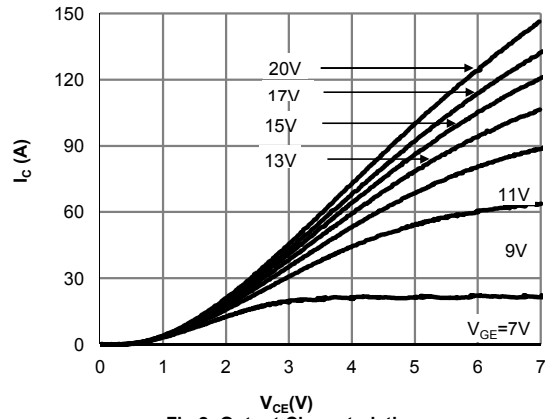
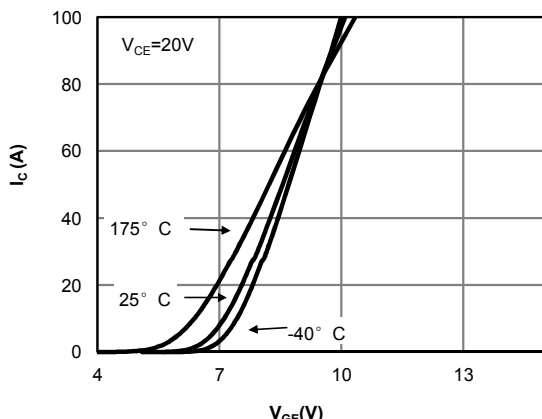
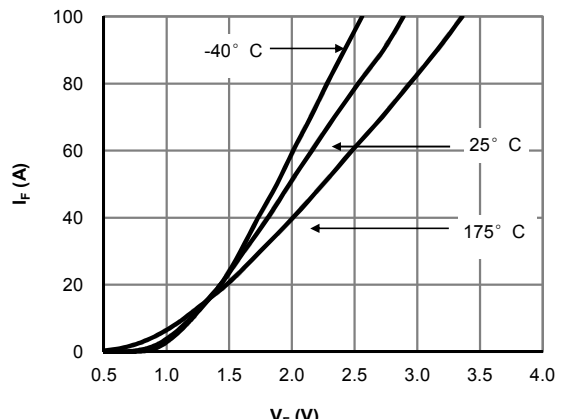
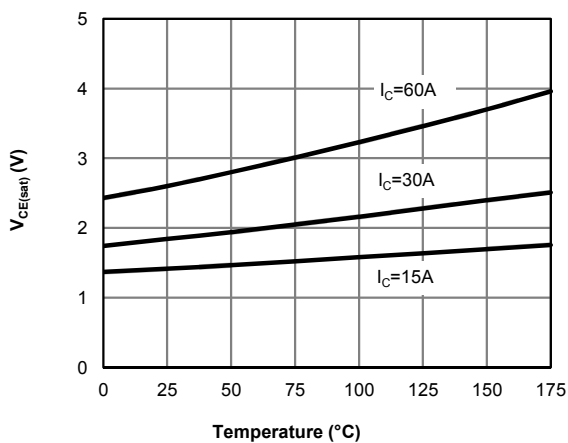
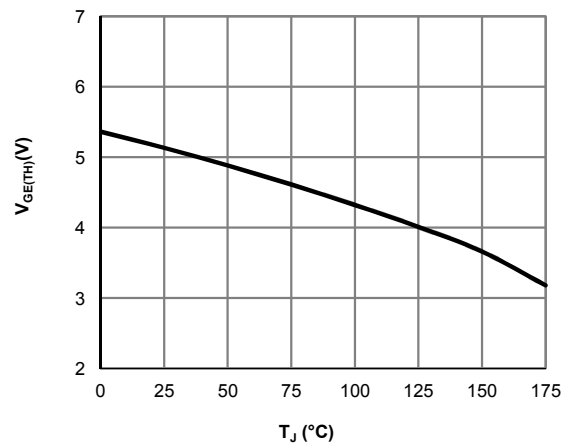
Parameter	Symbol	AOK30B135W1	Units
Maximum Junction-to-Ambient	$R_{\theta JA}$	40	$^\circ\text{C/W}$
Maximum IGBT Junction-to-Case	$R_{\theta JC}$	0.44	$^\circ\text{C/W}$
Maximum Diode Junction-to-Case	$R_{\theta JC}$	1.20	$^\circ\text{C/W}$

Note A: Capacitor charging saturation current limited by $T_{Jmax} < 175^\circ\text{C}$ and $t_p < 3\mu\text{s}$

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units	
STATIC PARAMETERS							
BV_{CES}	Collector-Emitter Breakdown Voltage	$I_C=1mA, V_{GE}=0V, T_J=25^\circ C$	1350	-	-	V	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C=30A$	$T_J=25^\circ C$	-	1.8	2.2	V
			$T_J=125^\circ C$	-	2.3	-	
			$T_J=175^\circ C$	-	2.5	-	
V_F	Diode Forward Voltage	$V_{GE}=0V, I_C=30A$	$T_J=25^\circ C$	-	1.6	1.9	V
			$T_J=125^\circ C$	-	1.73	-	
			$T_J=175^\circ C$	-	1.74	-	
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$V_{CE}=5V, I_C=1mA$	4.7	5.15	5.9	V	
I_{CES}	Zero Gate Voltage Collector Current	$V_{CE}=1350V, V_{GE}=0V$	$T_J=25^\circ C$	-	-	10	μA
			$T_J=125^\circ C$	-	-	800	
			$T_J=175^\circ C$	-	-	8000	
I_{GES}	Gate-Emitter leakage current	$V_{CE}=0V, V_{GE}=\pm 30V$	-	-	± 100	nA	
g_{FS}	Forward Transconductance	$V_{CE}=20V, I_C=30A$	-	31	-	S	
DYNAMIC PARAMETERS							
C_{ies}	Input Capacitance	$V_{GE}=0V, V_{CE}=25V, f=1MHz$	-	1932	-	pF	
C_{oes}	Output Capacitance		-	107	-	pF	
C_{res}	Reverse Transfer Capacitance		-	32	-	pF	
Q_g	Total Gate Charge	$V_{GE}=15V, V_{CE}=1080V, I_C=30A$	-	62	-	nC	
Q_{ge}	Gate to Emitter Charge		-	13	-	nC	
Q_{gc}	Gate to Collector Charge		-	29	-	nC	
R_g	Gate resistance	$V_{GE}=0V, V_{CE}=0V, f=1MHz$	-	1.75	-	Ω	
SWITCHING PARAMETERS, (Load Inductive, T_J=25°C)							
$t_{D(off)}$	Turn-Off Delay Time	$T_J=25^\circ C$ $V_{GE}=15V, V_{CE}=600V, I_C=30A,$ $R_G=10\Omega,$ Parasitic Inductance=150nH	-	129	-	ns	
t_f	Turn-Off Fall Time		-	148	-	ns	
E_{off}	Turn-Off Energy		-	1.47	-	mJ	
SWITCHING PARAMETERS, (Load Inductive, T_J=175°C)							
$t_{D(off)}$	Turn-Off Delay Time	$T_J=175^\circ C$ $V_{GE}=15V, V_{CE}=600V, I_C=30A,$ $R_G=10\Omega,$ Parasitic Inductance=150nH	-	154	-	ns	
t_f	Turn-Off Fall Time		-	208	-	ns	
E_{off}	Turn-Off Energy		-	1.63	-	mJ	

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Fig 1: Output Characteristic
 $(T_J=25^\circ\text{C})$

Fig 2: Output Characteristic
 $(T_J=175^\circ\text{C})$

Fig 3: Transfer Characteristic

Fig 4: Diode Characteristic

Fig 5: Collector-Emitter Saturation Voltage vs. Junction Temperature

Figure 6: $V_{GE(TH)}$ vs. T_J

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

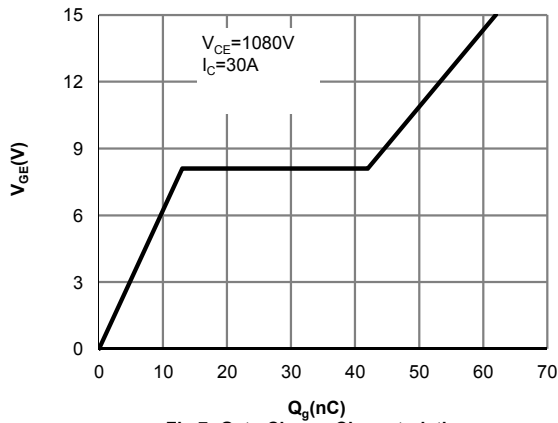


Fig 7: Gate-Charge Characteristics

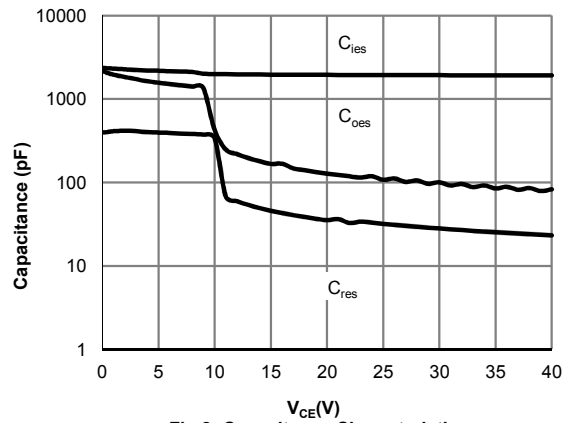


Fig 8: Capacitance Characteristic

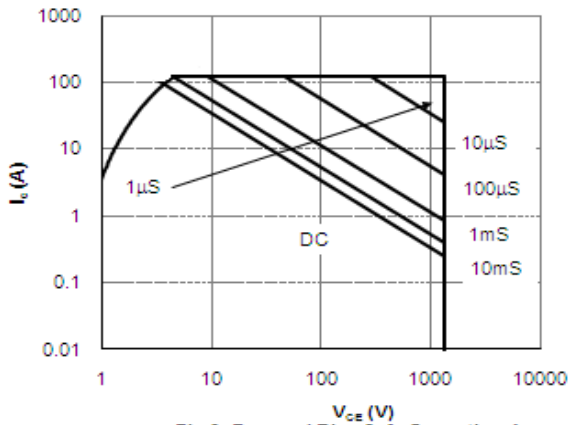


Fig 9: Forward Bias Safe Operating Area
($T_c=25^\circ\text{C}, V_{GE}=15\text{V}$)

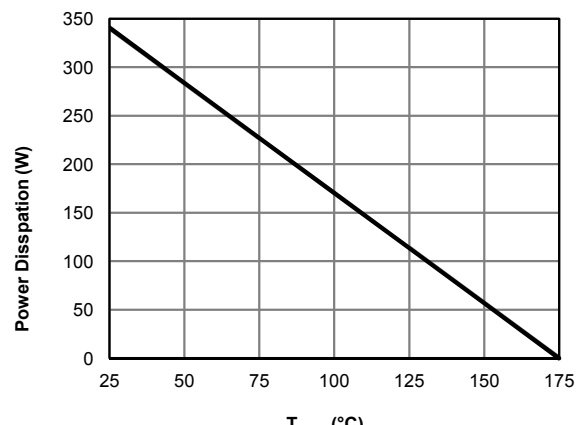


Fig 10: Power Dissipation as a Function of Case

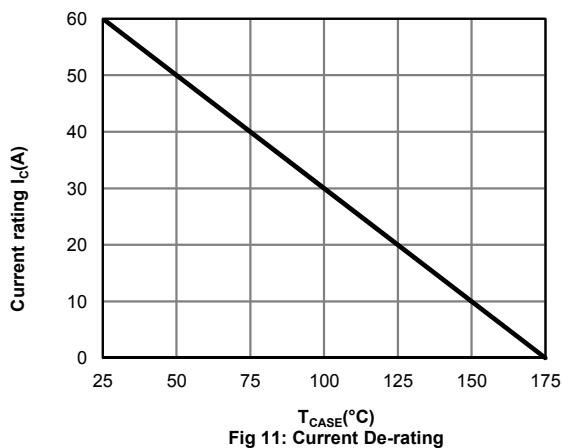


Fig 11: Current De-rating

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

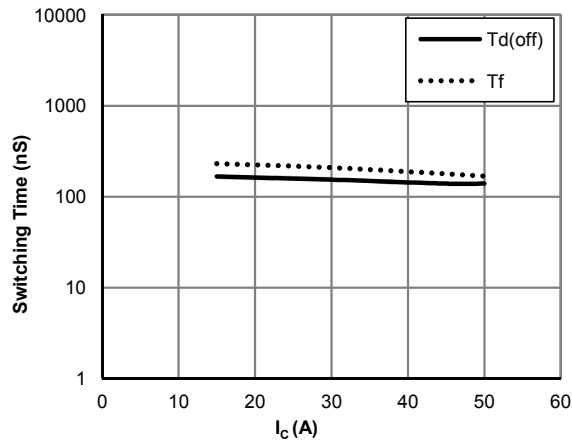


Figure 12: Switching Time vs. I_C
($T_J=175^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=600\text{V}, R_g=10\Omega$)

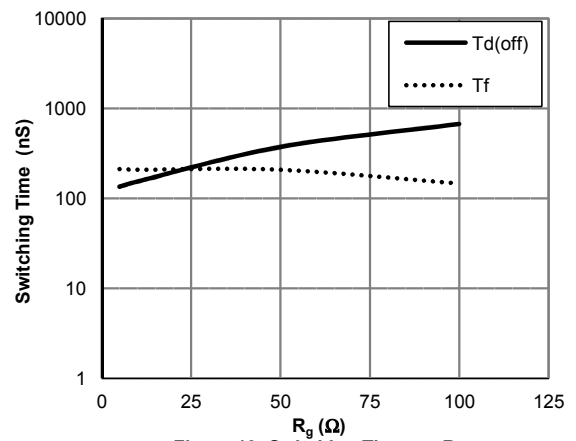


Figure 13: Switching Time vs. R_g
($T_J=175^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=600\text{V}, I_C=30\text{A}$)

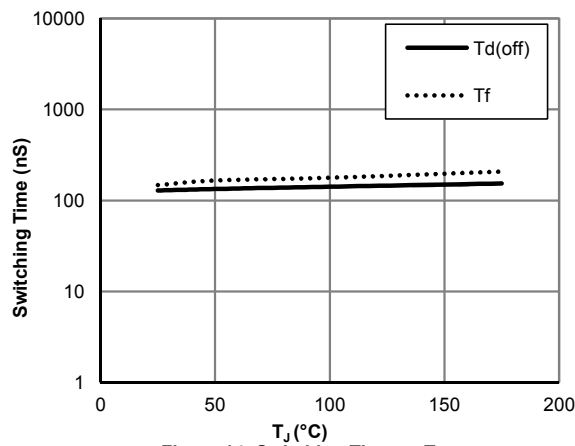


Figure 14: Switching Time vs. T_J
($V_{GE}=15\text{V}, V_{CE}=600\text{V}, I_C=30\text{A}, R_g=10\Omega$)

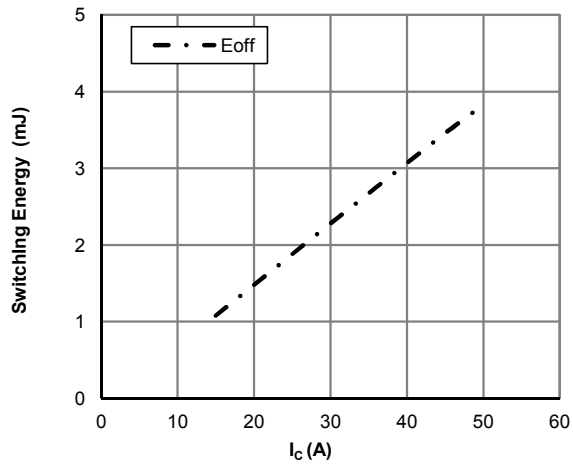
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Figure 15: Switching Loss vs. I_C
 ($T_J=175^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=600\text{V}, R_g=10\Omega$)

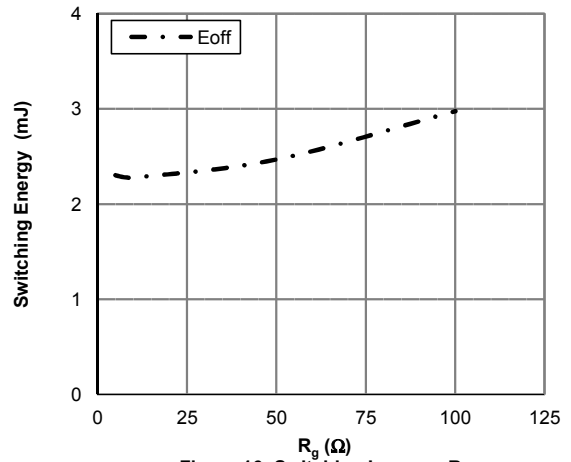


Figure 16: Switching Loss vs. R_g
 ($T_J=175^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=600\text{V}, I_C=30\text{A}$)

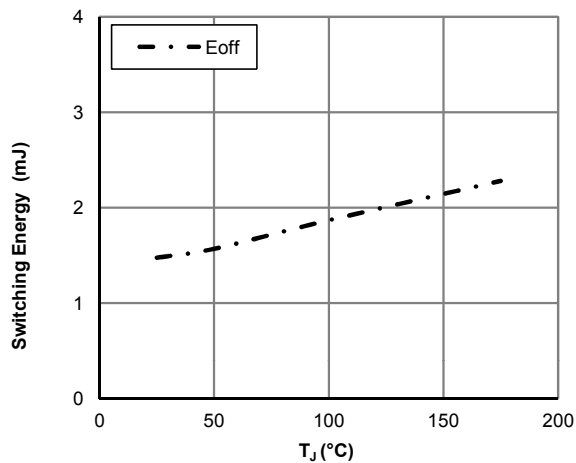


Figure 17: Switching Loss vs. T_J
 ($V_{GE}=15\text{V}, V_{CE}=600\text{V}, I_C=30\text{A}, R_g=10\Omega$)

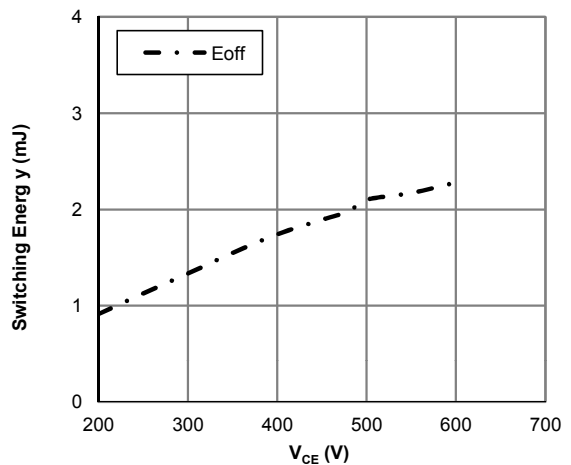
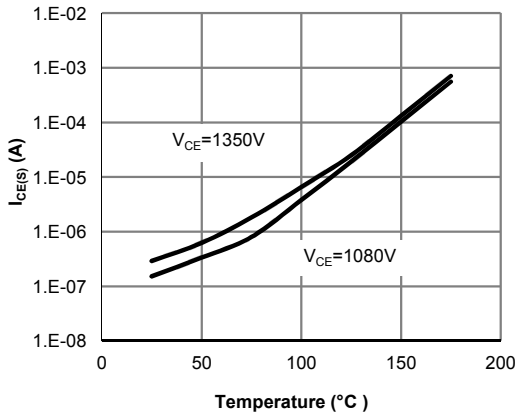
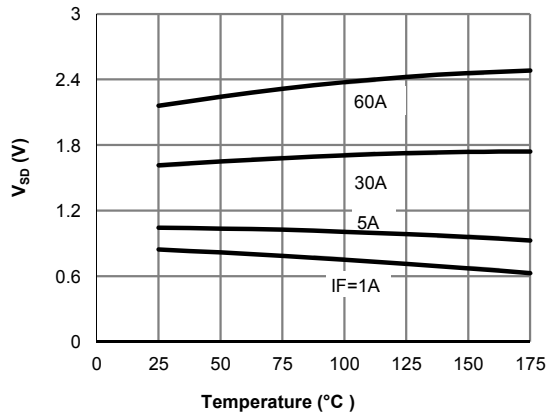
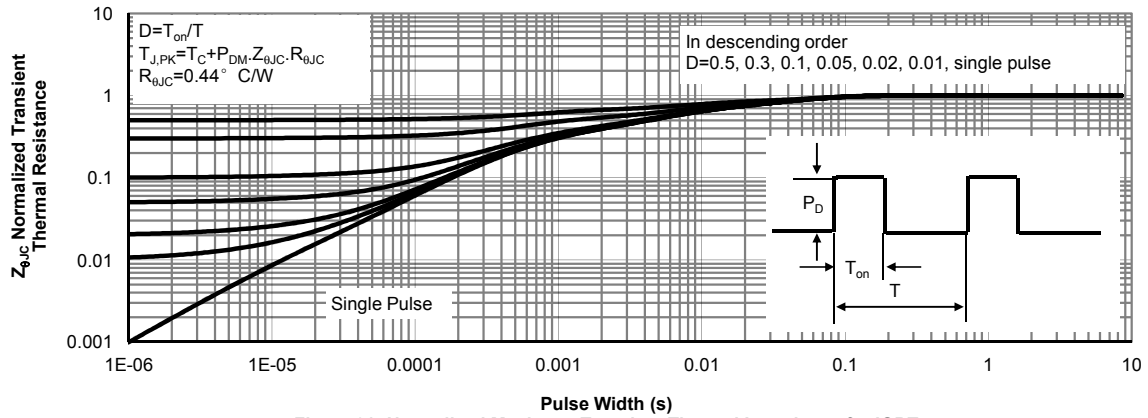
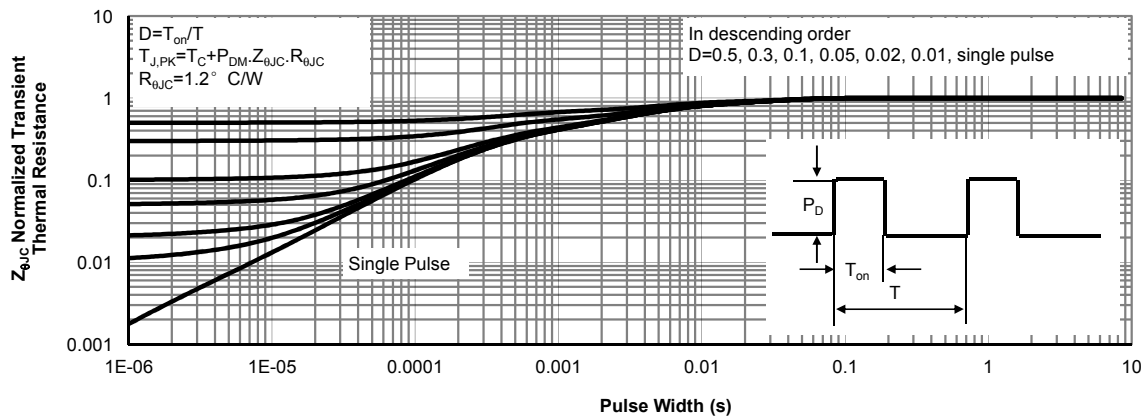
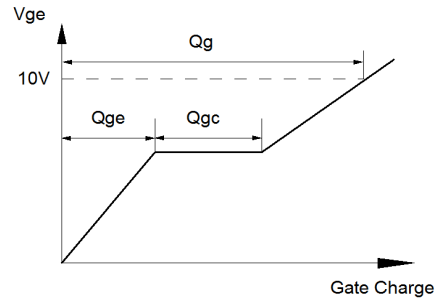
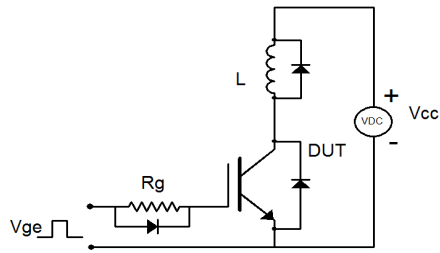


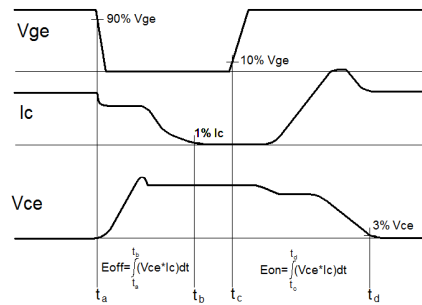
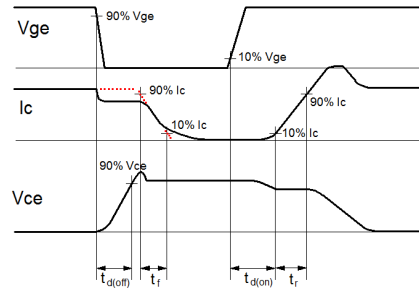
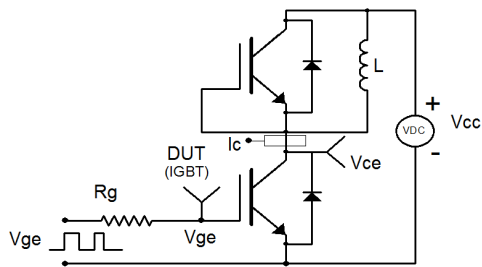
Figure 18: Switching Loss vs. V_{CE}
 ($T_J=175^\circ\text{C}, V_{GE}=15\text{V}, I_C=30\text{A}, R_g=10\Omega$)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Fig 19: Diode Reverse Leakage Current vs. Junction Temperature

Fig 20: Diode Forward voltage vs. Junction Temperature

Figure 21: Normalized Maximum Transient Thermal Impedance for IGBT

Figure 22: Normalized Maximum Transient Thermal Impedance for Diode

Gate Charge Test Circuit & Waveform



Inductive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

